

NOT RECOMMENDED FOR NEW DESIGN -NO ALTERNATE PART





DUAL SURFACE MOUNT TVS

Features

- IEC 61000-4-2 (ESD): Level 4, Air 16kV, Contact 8kV
- MIL STD 883C (ESD) HBM 16kV
- Low Leakage < 1µA @ 5.25V
- Low Capacitance (40pF Typical)
- Surface Mount Package Ideally Suited for Automated Insertion
- Totally Lead- Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

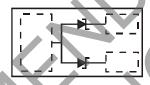
X1-DFN1006-3



Bottom View

Mechanical Data

- Case: X1-DFN1006-3
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 4
- Weight: 0.0009 grams (Approximate)



Top View Internal Schematic

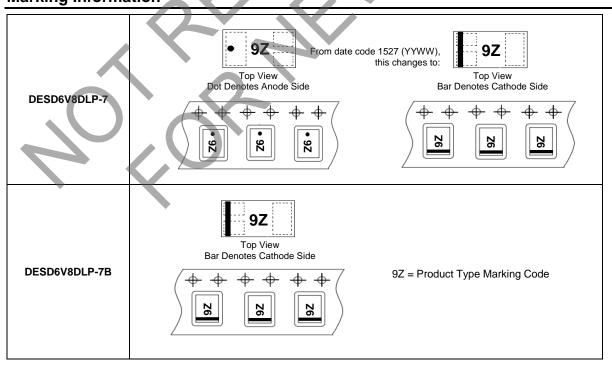
Ordering Information (Note 4)

Part Number	Case	Packaging
DESD6V8DLP-7	X1- DFN1006-3	3000/Tape & Reel
DESD6V8DLP-7B	X1- DFN1006-3	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Forward Voltage @ I _F = 10mA	V _F	1.25	V

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Peak Pulse Power (tp = 8x20µs) (Note 5) T _A = +25°C	P _{pk}	70	W
Power Dissipation (Note 5)	PD	385	mW
Thermal Resistance Junction to Ambient (Note 5) T _A = +25°C	RθJA	325	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

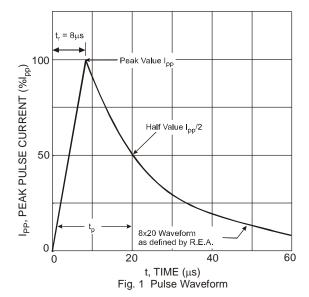
Reverse Standoff Voltage	Breal	kdown Vo V _{BR} @ I _T	ltage	Test Current	Maximum Reverse Leakage @ V _{RWM} (Note 6)			imum Dynamic Impedance f = 1kHz		Typical Total Capacitance CT VR = 0V, f = 1MHz
V _{RWM} (V)	Min (V)	Typ (V)	Max (V)	l⊤ (mA)	I _R (μA)	Zz	r @ Iτ (Ω)	Zzκ @ Izκ (Ω)	Izk (mA)	(pF)
5.25	6.4	6.8	7.2	5.0	1.0		30	300	0.5	40

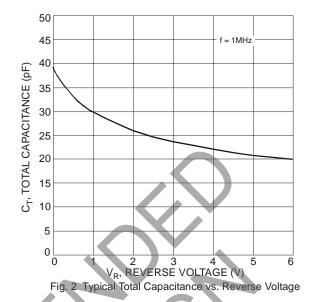
Notes:

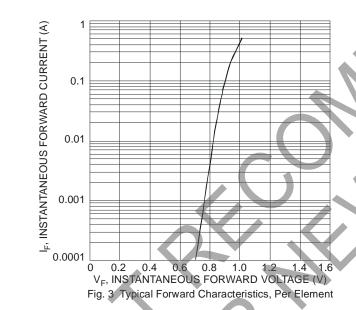
- 5. Device mounted on FR-5 PC board of size 1.0 x 0.75 x 0.62 inches
 6. Short duration pulse test used to minimize self-heating effect.
 7. Clamping voltage value is based on an 8 x 20µs peak-pulse current (IPP) waveform.

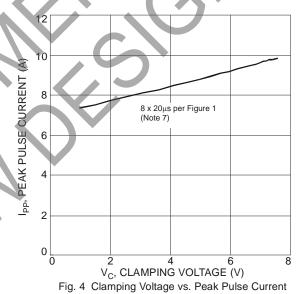










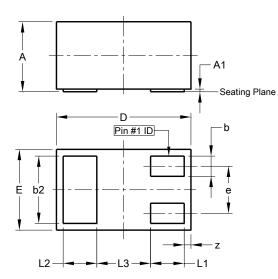




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-3

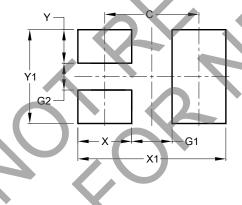


X1-DFN1006-3				
Dim	Min	Max	Тур	
Α	0.47	0.53	0.50	
A1	0.00	0.05	0.03	
b	0.10	0.20	0.15	
b2	0.45	0.55	0.50	
D	0.95	1.075	1.00	
Ш	0.55	0.675	0.60	
œ	1	14	0.35	
L 1	0.20	0.30	0.25	
L2	0.20	0.30	0.25	
L3	-	1	0.40	
Z	0.02	0.08	0.05	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1006-3



Dimensions	Value (in mm)
С	0.70
G1	0.30
G2	0.20
Х	0.40
X1	1.10
Υ	0.25
Y1	0.70



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